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Investigating Novel 3D Modular Schemes for Large Array Topologies: Power Modeling and Prototype Feasibility.

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University of York,
York, United Kingdom**

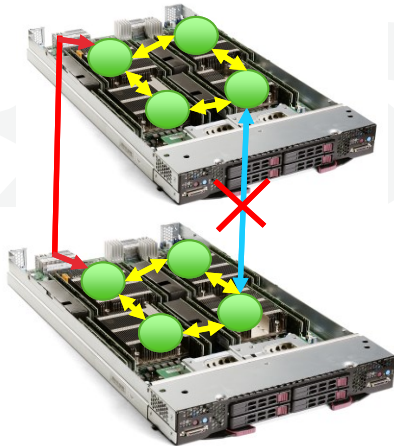


Background and Motivation

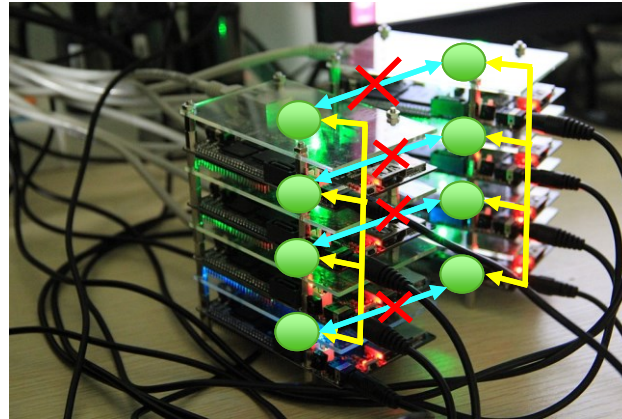
Alternatives to Rack-Mount

Background - Structural comparison

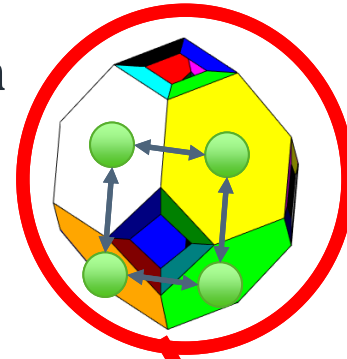
- Wiring effort (Power + data communication)
- Lengths of vertical and horizontal data channels
- Empty volume for cooling



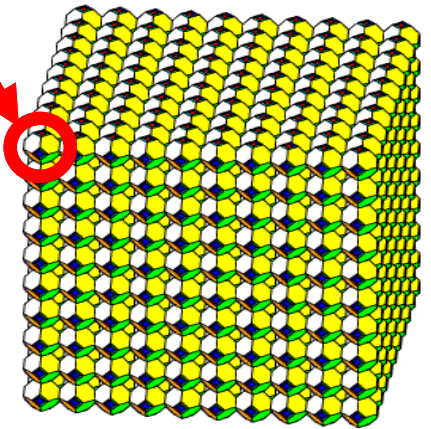
Adapted from [1]
Blade server



Adapted from [2]
Small single-board



External
DC Power supply



Our 'ball computer' packaging

(Vertical distance is for illustration purpose)

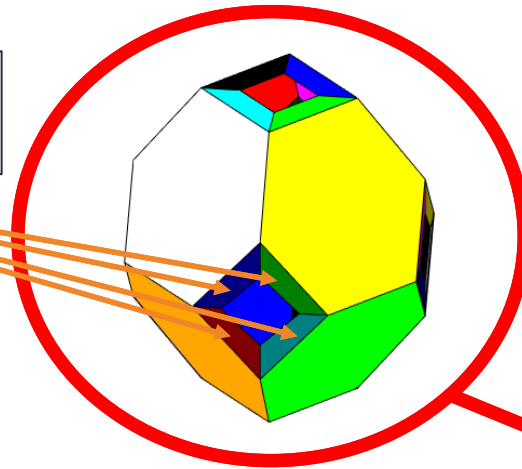
[1] https://upload.wikimedia.org/wikipedia/commons/thumb/d/d0/Supermicro_SBI-7228R-T2X_blade_server.jpg/1024px-Supermicro_SBI-7228R-T2X_blade_server.jpg

[2] https://upload.wikimedia.org/wikipedia/commons/thumb/2/27/Cubieboard_HADOOP_cluster.JPG/1024px-Cubieboard_HADOOP_cluster.JPG

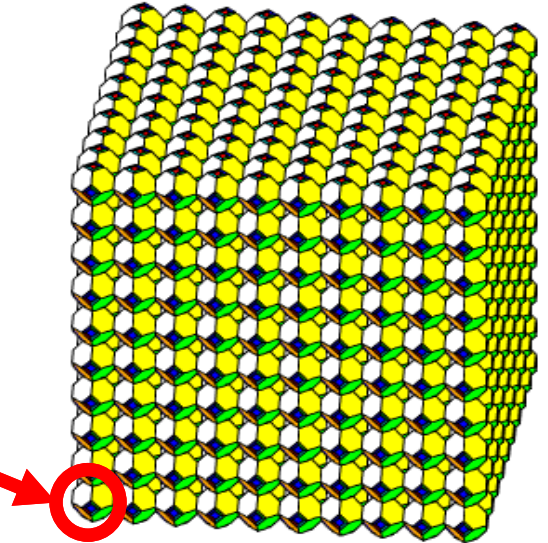
Motivation - Power grid simulation

- This power grid system does not exist in conventional rack/cabinet systems.
 - Direct external power sources supplied to each blade/rack server
- In this work, in contrast, how does it impact on the scalability in the concept of hexagonal-tile system for large scales?

External power source connections
(for any external trapezoidal faces)




8 computing nodes per ball



Introduction – from tile to ball

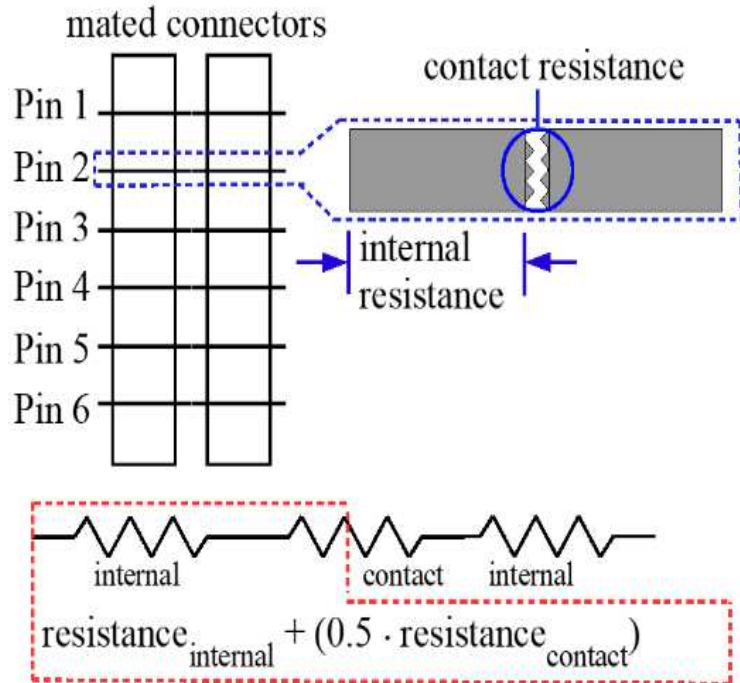
1D/2D/3D compossible configurations (prototype)





Simulation and Prototype Details

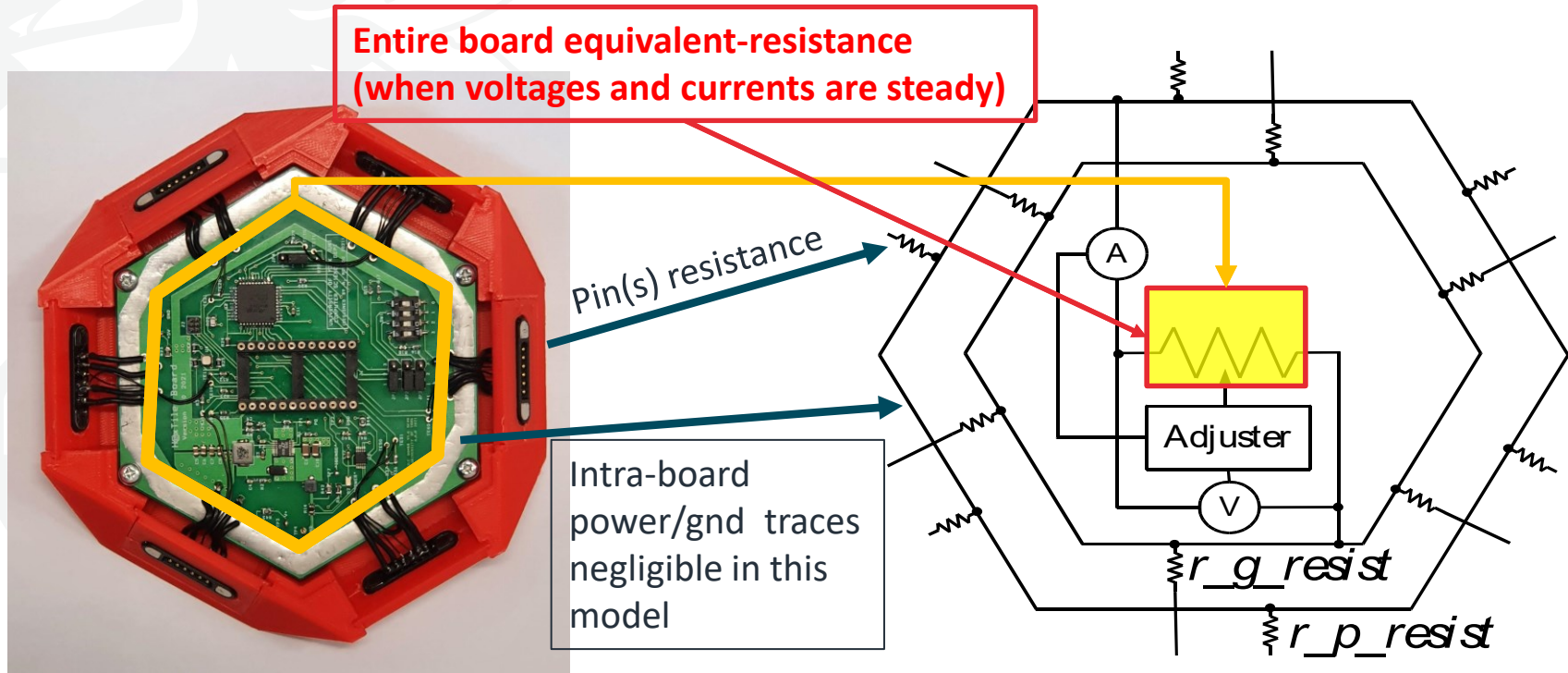
Model – Connector pin resistance



- ‘Off-the-shelf’ connectors in the current prototype
- Variants of (custom-made) more suitable connectors can be used for different power and data communication requirements.

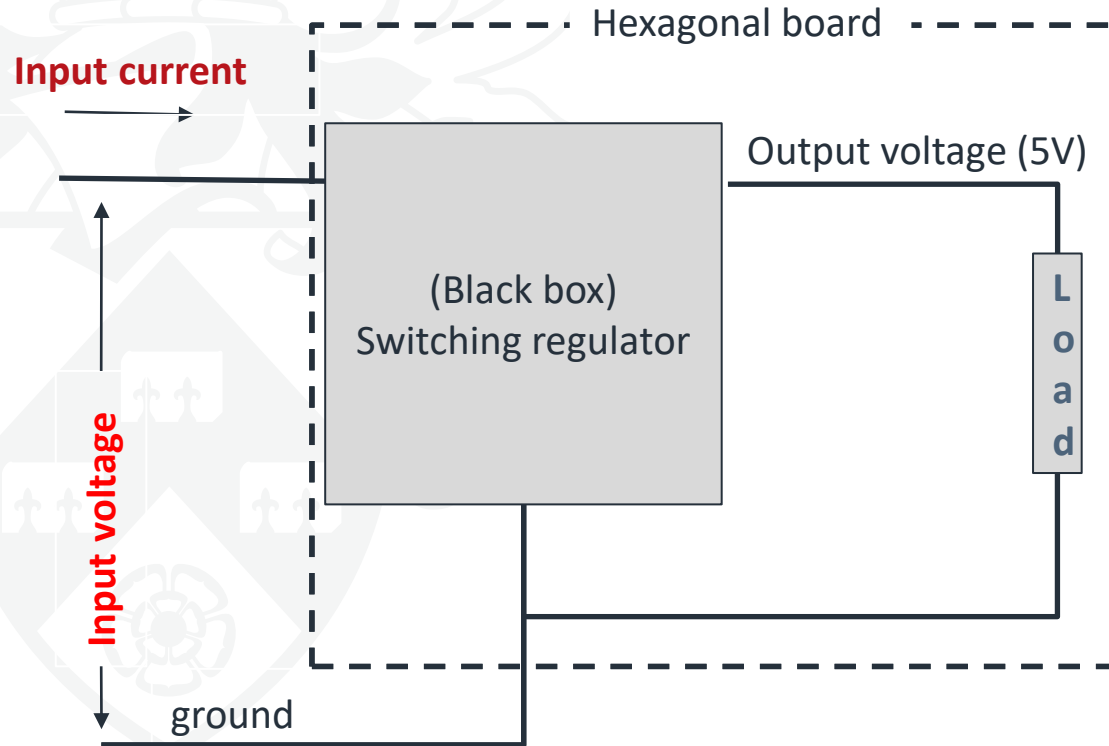
Model – Simplified board-resistance model

- Switching regulator models take long simulation times.
- A Simplified model has been created for our scalability simulations.



Model – Simplified board-resistance model

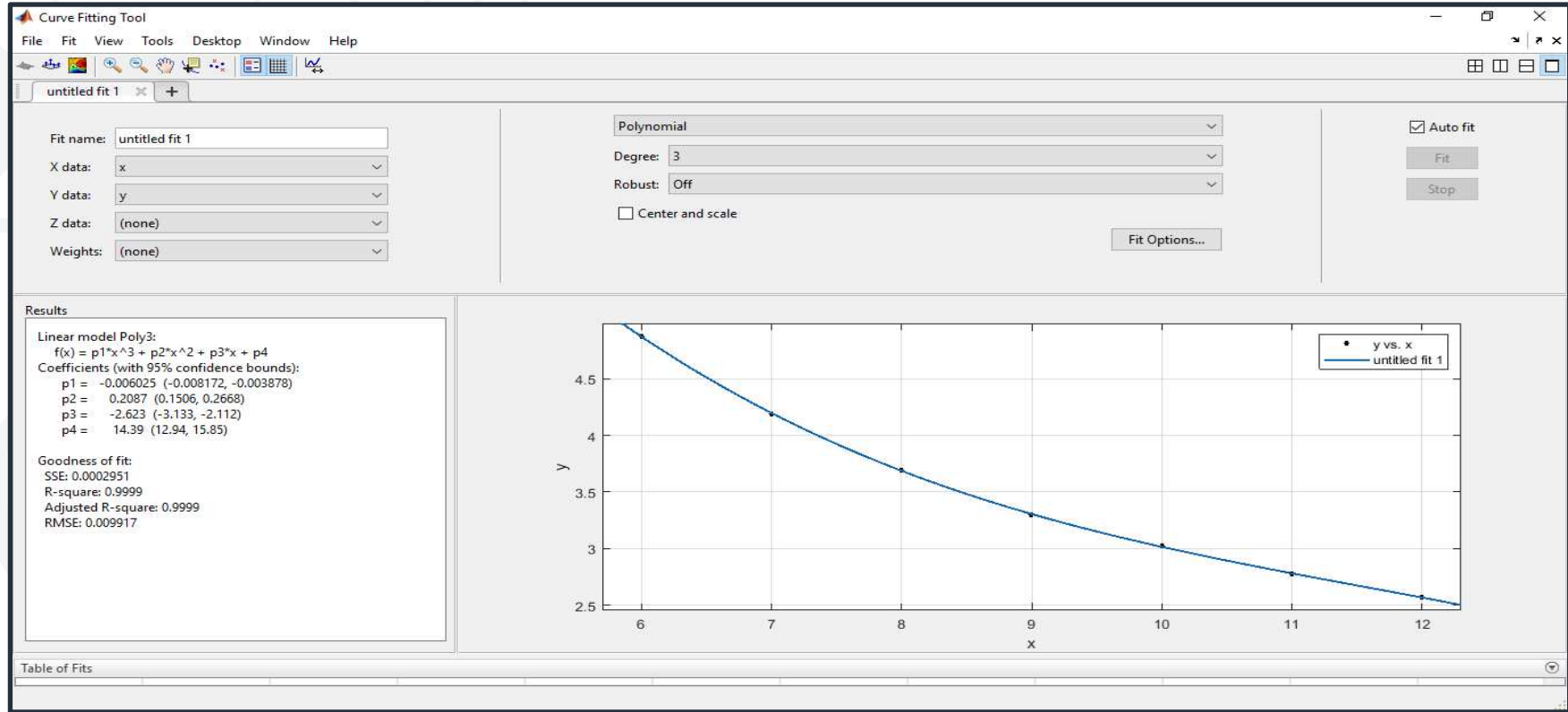
Curve fitting for the regulator and load




Input Voltage (V)	Load Resistance (Ω)	Input Current (A)
12	1	2.5706
11	1	2.775
10	1	3.0244
9	1	3.2982
8	1	3.695
7	1	4.1902
6	1	4.8733

Model – Simplified board-resistance model

Curve fitting for the regulator and load (for a constant load-resistance)



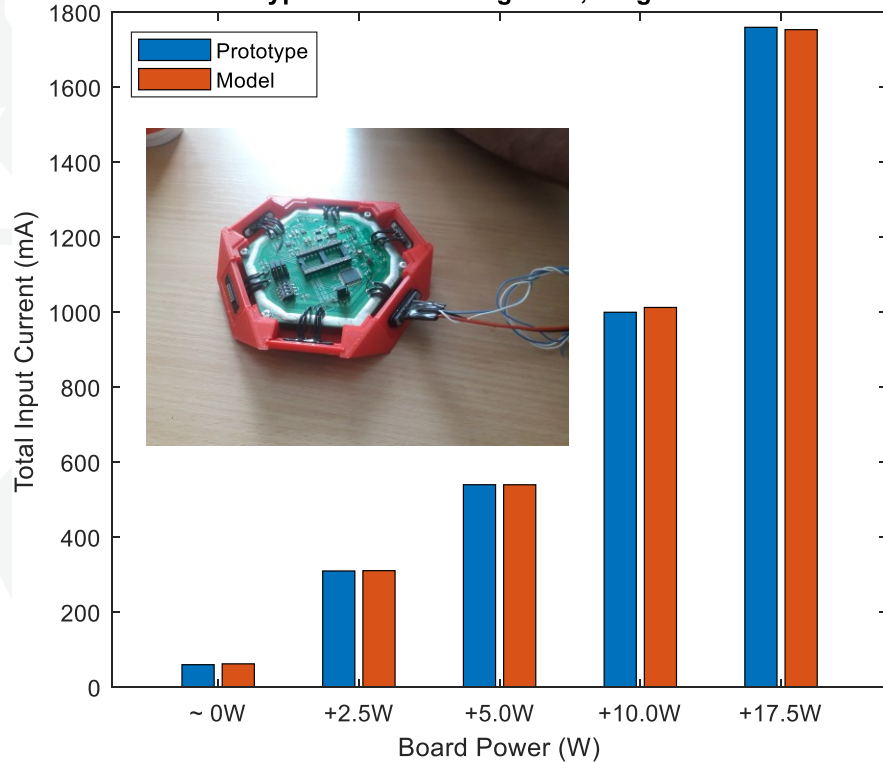


Validation Simulator vs. Prototype

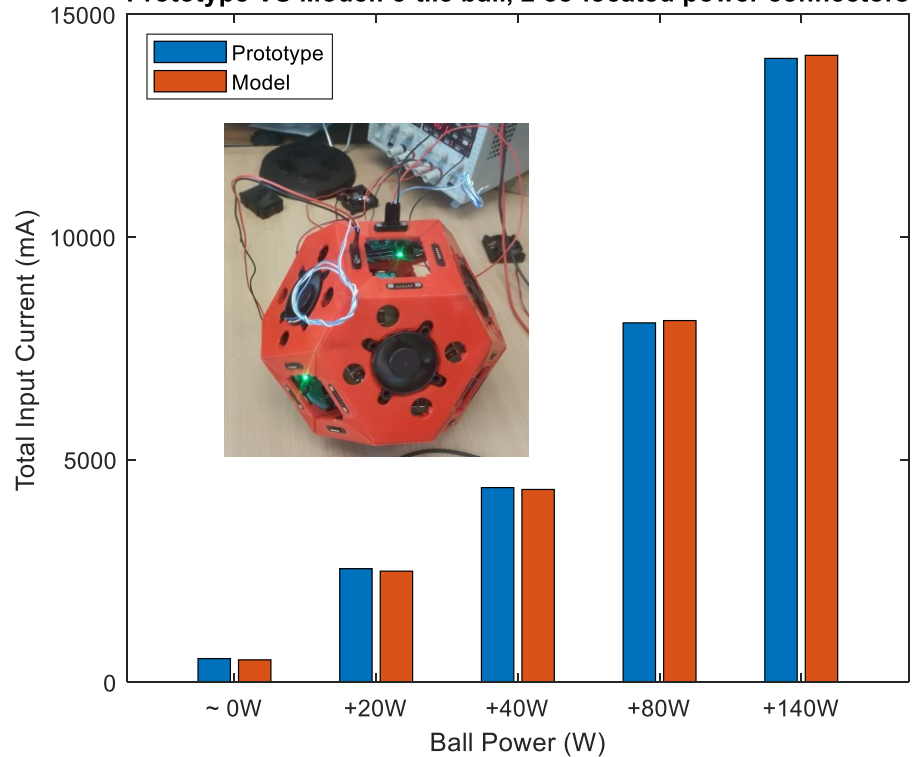
Model Validation – switching vs prototype

Input-current validation

Prototype VS Model: Single tile, Single connector



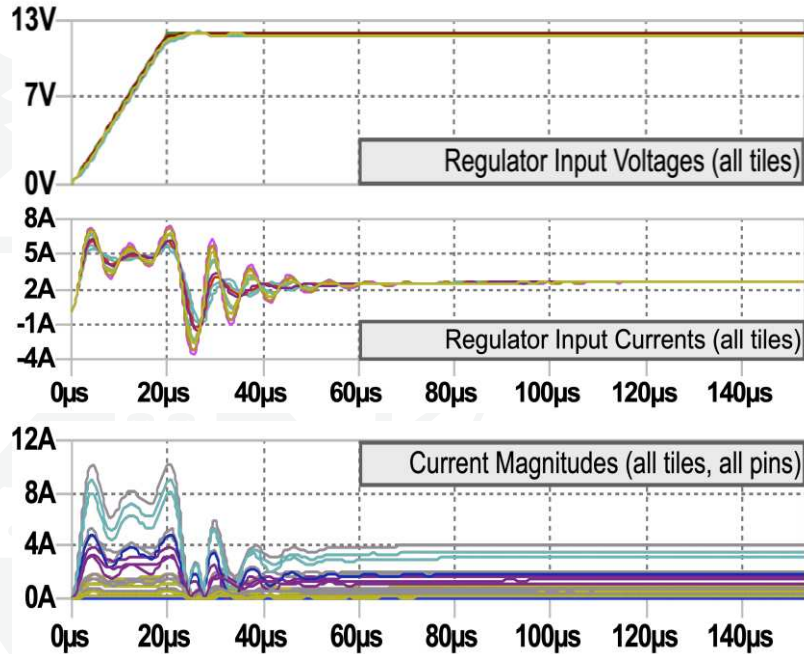
Prototype VS Model: 8-tile ball, 2 co-located power connectors



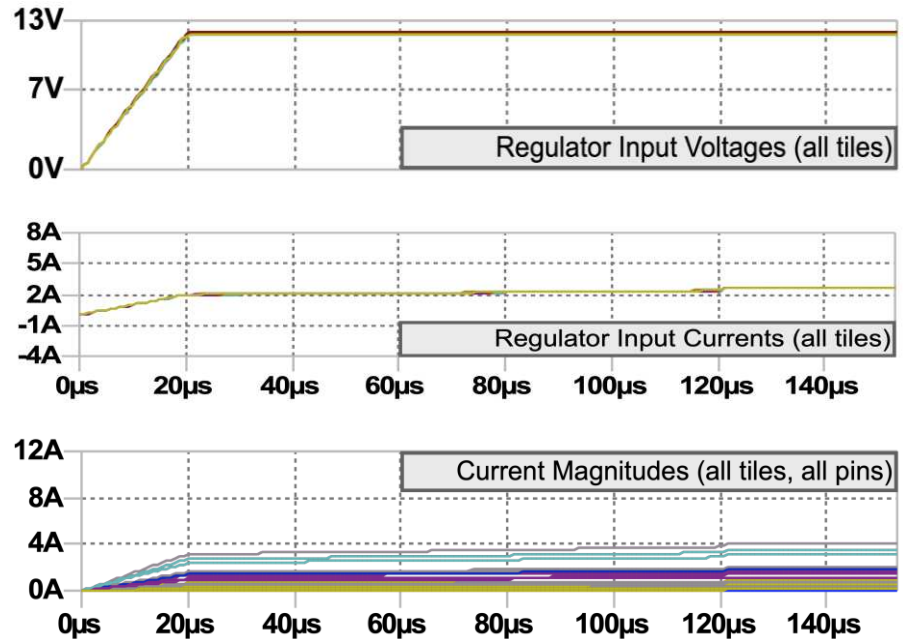
*LT3976 regulators, from Analog Devices, Inc., are used in our prototype.

Model validation

Switching VS Simplified model, 3x3x3-ball



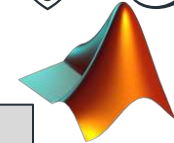
(a) Simulation based upon LT3976 regulator model



(b) Simulation using simplified (faster) model

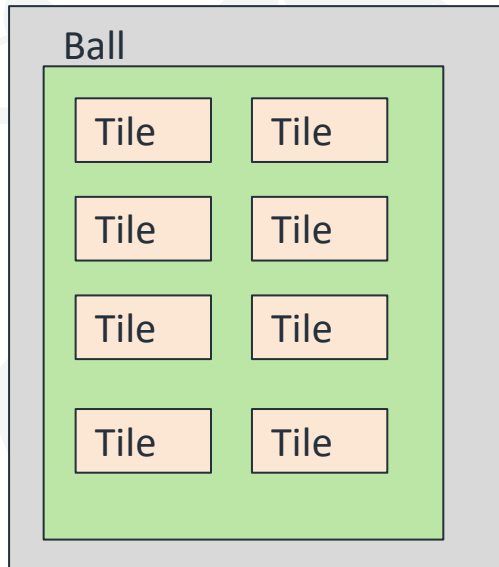
* External power supplied to all surface power connectors

Simulation framework

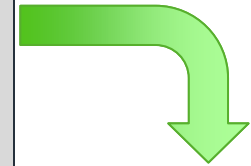
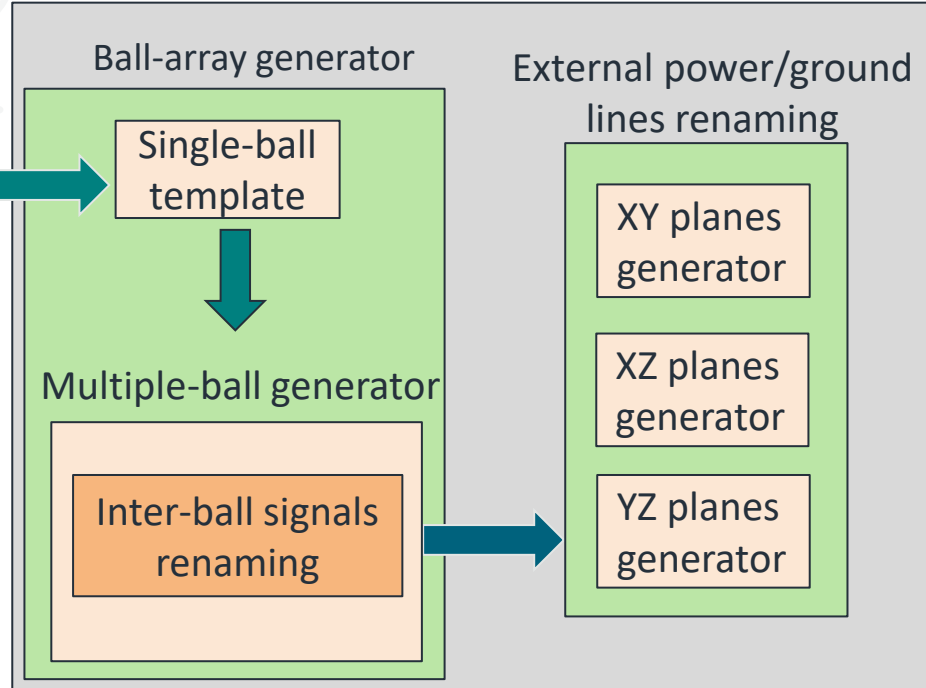


MATLAB *

Manual:
(tile-level parameterizable)



Automated: SPICE source-code files generator



LTspice



* https://upload.wikimedia.org/wikipedia/commons/thumb/2/21/Matlab_Logo.png/800px-Matlab_Logo.png

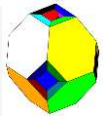
** https://upload.wikimedia.org/wikipedia/commons/thumb/8/86/Analog_Devices_Logo.svg/1920px-Analog_Devices_Logo.svg.png



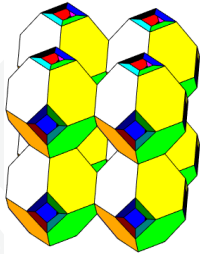
Scalability Evaluations

Scalability Results

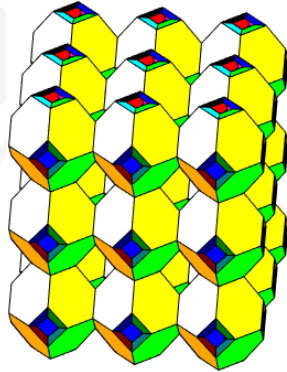
Experimental scenarios



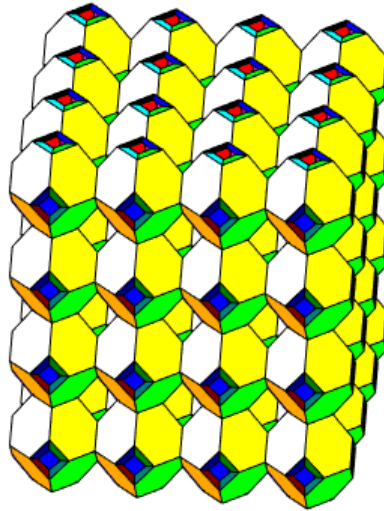
1 ball
8 tiles



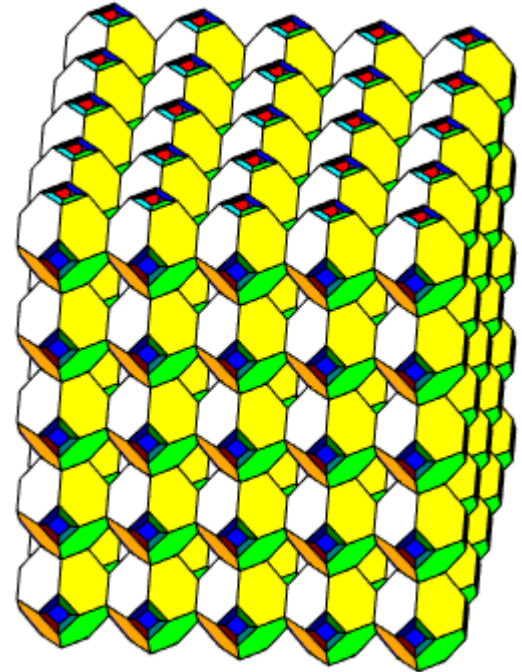
2x2x2 cube
64 tiles



3x3x3 cube
216 tiles



4x4x4 cube
512 tiles

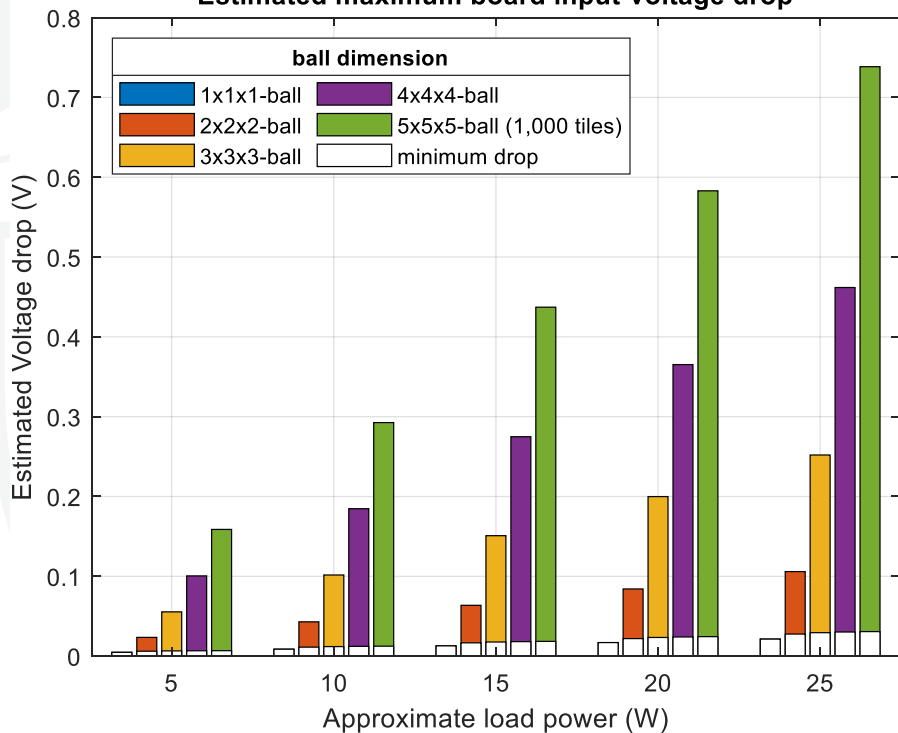


5x5x5 cube
1,000 tiles

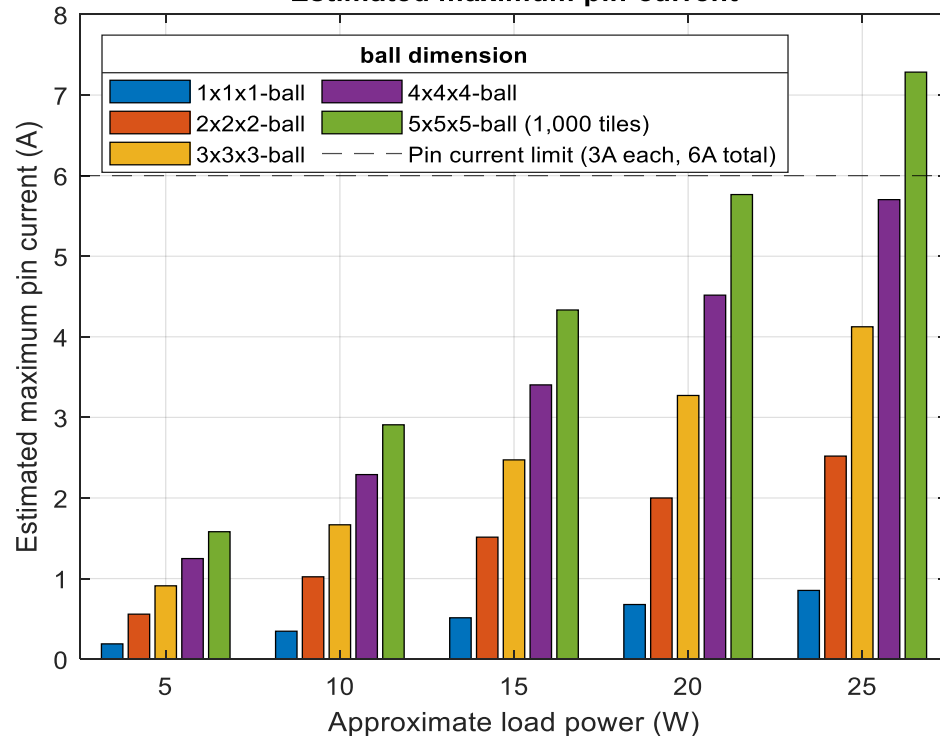
Scalability Results

Uniform load-power per tile allocation

Estimated maximum board input-voltage drop



Estimated maximum pin-current



* Parameter: 50 mOhms mated pin-pair

Further Optimization

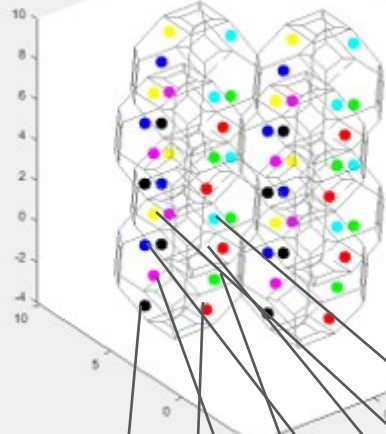
Brute Force ?

Genetic algorithms ?

GA load-power per tile optimization



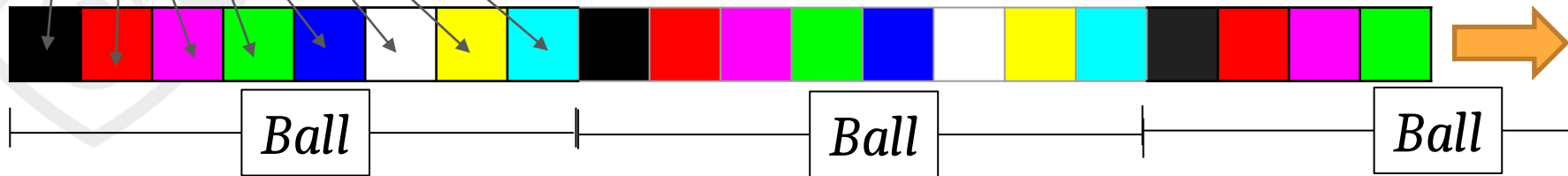
Non-uniform load-power per tile allocation



Method 1: Single-tile per gene

- Large search space (for a large system)
- Suitable for arbitrary...
 - non-symmetric external power connection
 - non-symmetric system shapes

Chromosome





GA load-power per tile optimization

Non-uniform load-power per tile allocation

Method 2: Center-distance allocation

Example: 2x2x2-ball system (64 tiles)

Single-tile per gene allocation:

- 5 power steps, 64 nodes

= 5^{64} cases

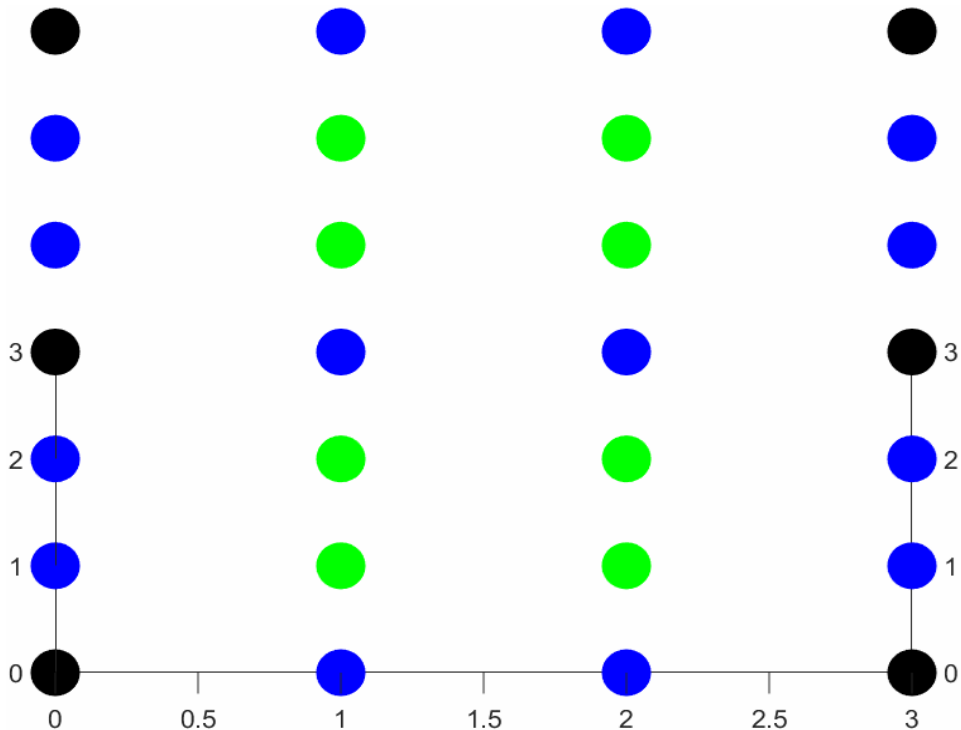
≈ 5.42×10^{44} cases!

Center-distance allocation:

- 5 power steps,

- 4 groups of nodes

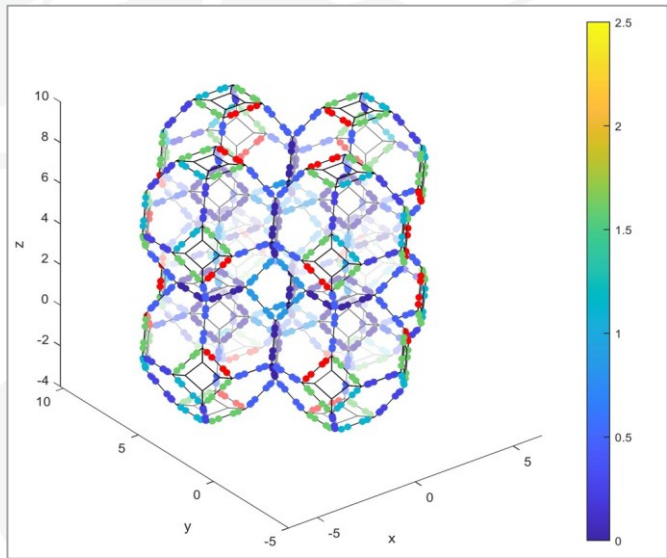
= 5^4 cases = 625 cases (Search space reduced)



GA load-power per tile optimization

Constraints: total 1000W-load per system, 3A connector pin

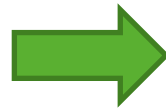
During optimisation



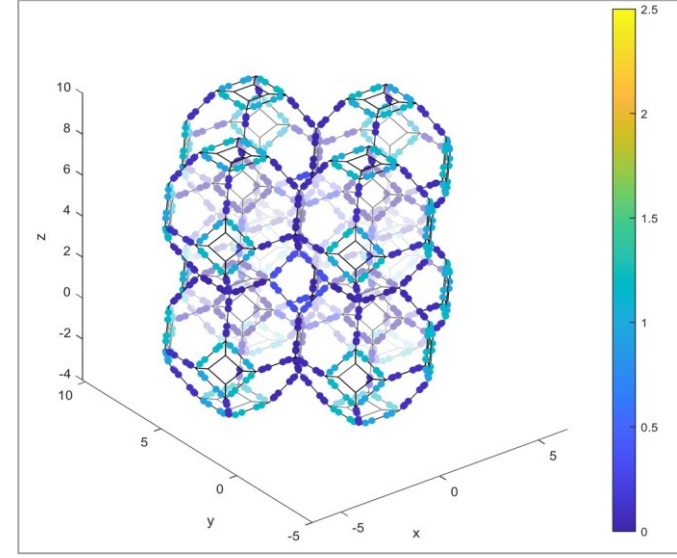
2.5 A

0 A

1000W, with pins overloaded



Stopping criteria reached



2.5 A

0 A

1000W, with pins under current limit

*Red dots = Overloaded pin currents (> 2.5A, for illustration purpose)



Outcomes and Implications

Outcomes

- What we have done ...
 - **Hardware prototype system**
 - Testing the prototype
 - **Models and simulation framework**
 - Validating accuracy
 - Switching model vs hardware prototype
 - Switching model vs simplified model
 - Scalability projection
 - Power-grid optimization framework
 - Power pattern on a large scale
 - Visualization

Implications

- **Existing prototype:** Allowing to achieve the system of the order of 1,000 processor tiles, even with a very basic prototype construction.
 - With highly optimized fabrication, > 1000 tiles could be achievable.
 - Reducing size = Higher density
 - Current ball size: Many thousand processors in a server cabinet volume
 - Cooling
 - More detailed investigation needed
 - But with the current tool capabilities, the power consumed at pins and tiles can be predictable.
 - Allowing a cooling model to be developed in the future

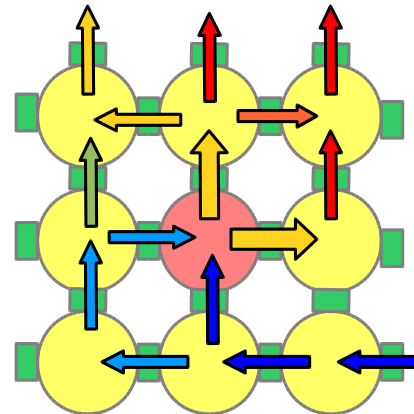
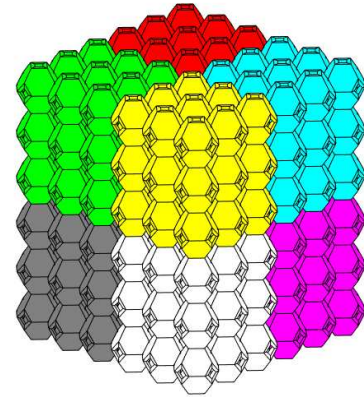
Possible future works

Simulation framework

- Model: Temperature/Manufacture-affected pin-resistance variability
- Opensource SPICE simulator (Ngspice) for simplified models. (In progress)
- Simulations on a computing cluster (In progress)
- Interfacing with an interconnection network simulator (BookSim2, In progress)
- Cooling design and simulation

Hardware developments

- **Reducing hops:** Localized shared physical wires?
 - Bus: Beneficial for broadcast-intensive workloads?
Concern: Serialization, bandwidth issues?
- **Power reservoir:**
 - Intra/Inter-ball power storage?
 - Reducing voltage/current spike
- **In-System Cooling:**
 - Intra-ball fan/pump/impellor?



Q&A

Thank you for your attention

